STN LCD Driver Panasonic

MN863830EFH

240-Output STN Segment Driver

Overview

The MN863830EFH is a 240-output segment driver IC for dot matrix STN LCD panels. It latches 8-bit or 12-bit parallel data transferred from an LCD controller and generates the LCD drive signals.

In combination with an LCD common driver IC, MN8637 series, this IC is optimal for implementing low-power LCD modules. Since this IC also provides an LCD drive voltage compensation function, it can implement high-quality LCD display modules with minimal crosstalk. It supports both color and monochrome displays.

■ Features

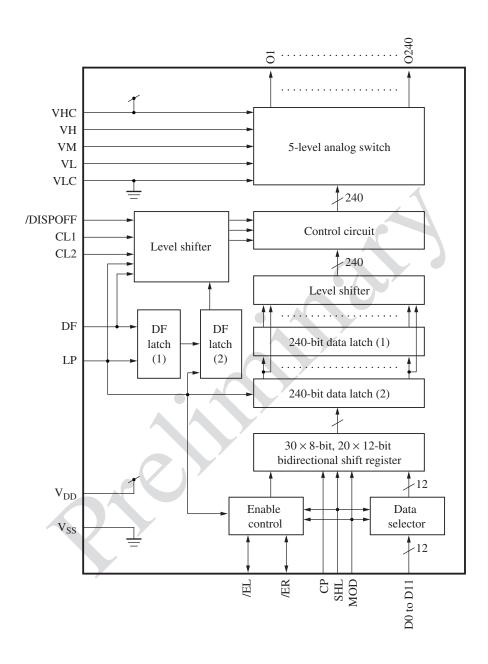
- Supports LCD drive voltages up to 6.0 V.
- Provides 240 LCD drive outputs.
- Provides an LCD drive voltage compensation function to implement high-quality LCD display modules with minimal crosstalk.
- Inverts the LCD drive voltage by signal alternation.
- Provides 5 LCD drive voltage input pins: VHC, VH, VM, VL, and VLC
- Built-in voltage conversion block (level shifter) allows interfacing with LCD controllers with supply voltages in the range from 2.5 V to 5.5 V.
- Built-in bidirectional shift register allows arbitrary direction of the output data transfer and allows easy mounting in large-screen applications.
- Supports multistage cascade connection to drive high-resolution LCD panels.
- Supports both 8-bit and 12-bit parallel input mode.
- The 8-bit and 12-bit parallel input modes allow data rates 1/8 or 1/12 of those required with conventional serial transfer devices for lower power consumption.
- Provides a power saving function, in which all but one driver are set to standby mode and disable to input display data, for even lower power consumption in LCD modules with multistage cascade connection.

Applications

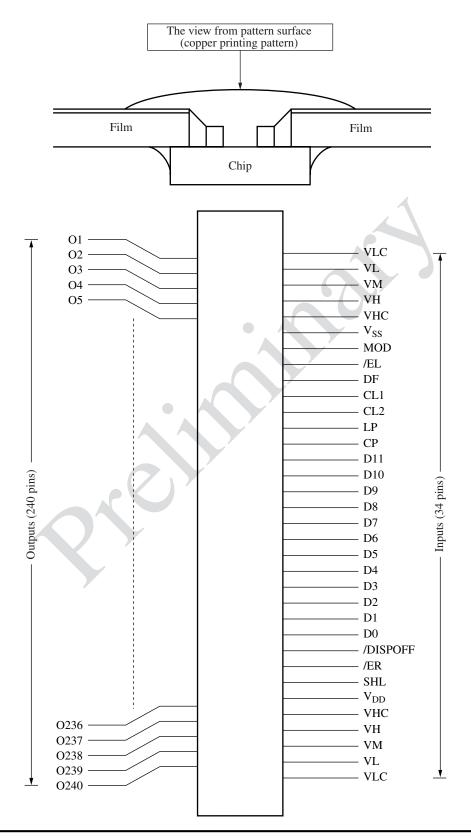
• Word processors, PDAs, and other portable information terminals

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■ Block Diagram



■ Pin Arrangement



■ Pin Descriptions

Pin No.	I/O	Function	Description
D0 to D11	I	Display data inputs (12 bits)	Parallel input of display data in 8-bit or 12-bit units. • In 8-bit parallel input mode, the 8 pins D0 to D7 are used for data input. The 4 pins D8 to D11 should be tied to V _{DI} or V _{SS} . • In 12-bit parallel input mode, the 12 pins D0 to D11 are used for data input.
O1 to O240	0	LCD drive outputs	These pins output the LCD drive voltages.
SHL	I	Shift direction selection	Switches the shift register data shift direction, and the /ER and /EL pin I/O mode.
СР	I	Shift clock input	The shift register transfer clock input. The shift register operates on the falling edge of this signal.
LP	I	Latch signal input	The DF signal and the shift register data are latched on the falling edge of this signal, and the latched data is output.
/DISPOFF	I	Display off input	The LCD drive outputs output the VM level regardless of the data while this pin is low.
CL1	I	LCD compensation voltage (VHC and VLC) control	Controls the period for the LCD compensation voltage (VHC and VLC) output to the LCD drive output pins according to the display data.
CL2	I	LCD compensation voltage (VM) control	Controls the period for the LCD compensation voltage (VM) output to the LCD drive output pins according to the display data.
DF	I	Alternation signal input	Performs signal alternation for the LCD drive voltage.
V_{DD}	Power supply	Logic system power supply	Power supply used for the logic circuits
V _{SS}	Power supply	GND	GND
VH (2 pins)	Power supply	Drive power supply	LCD drive power supply
VL (2 pins)	Power supply	Drive power supply	LCD drive power supply
VM (2 pins)	Power supply	Drive power supply	LCD drive power supply, (LCD compensation power supply)
VHC (2 pins)	Power supply	Drive power supply	LCD drive power supply, (LCD compensation power supply) Used as the power supply for the LCD drive circuit.
VLC (2 pins)	Power supply	Drive power supply	LCD drive power supply, (LCD compensation power supply) Connected internally to the V_{SS} pin.
/EL	I/O	Enable signal input and output	Data input/output for the chip enable signal
/ER	I/O	Enable signal input and output	Data input/output for the chip enable signal
MOD	I	Mode selection (with a pull-up resistor)	MOD Low 8-bit parallel input High 12-bit parallel input

Panasonic MN863830EFH

■ Function Descriptions

1. Control circuit for bidirectional shift register

This IC includes two circuits, an enable control circuit and a data selector, that control the built-in bidirectional shift register.

1.1 Enable control circuit

This circuit consists of a base-30 counter circuit (for 8-bit parallel input mode), a base-20 counter circuit (for 12-bit parallel input mode), and a control circuit for the chip enable I/O circuit.

This counter counts clock pulses and outputs a carry on the falling edge of the 30th clock cycle (in 8-bit parallel input mode) or the 20th clock cycle (in 12-bit parallel input mode). This corresponds to the completion of the shift register data shift operation. This carry stops the data shift clock internally to the IC, and places the counter and the shift register in the stopped state. When LP signal goes high, the base-30 and base-20 counters are reset and set to the counter wait state (standby state).

The standby state is not cleared until the chip enable I/O signal (/EL and /ER) that corresponds to shift direction goes low. When that chip enable signal goes low, the data shift clock and counter start operating again.

When this IC is connected in the serial cascade form, the counter carry signal is used as the chip enable signal for the driver IC in the next stage. The result of this operation is that at the completion of each 30 clock cycles (in 8-bit parallel input mode) or 20 clock cycles (in 12-bit parallel input mode), the next driver IC in sequence goes to the active state and the total power consumption of the whole LCD panel is reduced.

1.2 Data selector circuit

This circuit determines, based on the state of the SHL pin, the data shift direction of the internal shift register and the I/O mode of the chip enable I/O pin as shown in tables 1-a and 1-b.

2. 30 × 8-bit (8-bit parallel input mode)/20 × 12-bit (12-bit parallel input mode) bidirectional shift register The IC internal 8-bit parallel 30-stage and 12-bit parallel 20-stage bidirectional shift registers operate on the falling edge of the clock pulse.

In 8-bit parallel input mode, since the input data is divided into 8-bit parallel units, the shifting of the 240 output units of data requires 30 clock cycles. (See Timing Charts 1 and 3.)

In 12-bit parallel input mode, since the input data is divided into 12-bit parallel units, the shifting of the 240 output units of data requires 20 clock cycles. (See Timing Charts 2 and 4.)

The shift direction is selected by the SHL pin as shown in tables 1-a and 1-b.

3. 240-bit data Latch (2)

The 240-bit data latch (2) holds the 240 bits of data acquired by the shift register for a single horizontal scan period (1H).

Data is latched on the falling edge of the LP signal, which is the start pulse for the horizontal scan period, held for 1H, and the next data is latched on the next falling edge on the LP signal.

Timing Chart 3 shows the shift register and latch operation for the first stage segment driver when multiple driver ICs are connected in series and operated in 8-bit parallel mode.

Also, Timing Chart 4 shows the shift register and latch operation for the first stage segment driver when multiple driver ICs are connected in series and operated in 12-bit parallel mode.

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■ Function Descriptions (continued)

4. Level shifters

The level shifters convert levels from the logic circuit signal levels ($V_{DD} = high$, $V_{SS} = low$) to the signal levels (VHC = high, VLC = $V_{SS} = low$) used by the LCD drive circuits, such as the analog switches. The IC includes two types of level shifters, one is for 240 bits display data and the other is for control signals.

240-bit data latch (1)

The 240-bit data latch (1) holds the 240 bits of display data acquired by the 240-bit data latch (2) for an additional 1H. Thus the 240-bit data latch (1) holds the data for the previous line from the display data currently being scanned. Data is latched on the falling edge of the LP signal, held for 1H, and the next data is latched on the next falling edge on the LP signal.

5-level analog switch

The 5-level analog switch is controlled by the control circuit and selects one of the 5 drive voltages (VHC, VH, VM, VL, and VLC), and outputs the selected levels to the 240 LCD drive output pins.

7. DF latch (1)

The DF latch (1) holds the DF data for a single horizontal scan period (1H).

Data is latched on the rising edge of the LP signal, which is the start pulse for the horizontal scan period, held for 1H, and the next data is latched on the next rising edge on the LP signal.

8. DF latch (2)

The DF latch (2) latches the data acquired by the DF latch (1) on the falling edge of the LP signal, holds that data for 1H, and latches the next data on the next falling edge of the LP signal.

(Timing Charts 3 and 4 show this latch operation.)

9. Control circuit

The voltage selected by the 5-level analog switch is determined by the 240-bit data latch (1), the 240-bit data latch (2), the /DISPOFF signal, the CL1 signal, the CL2 LP signal, the DF input, and DF latch (2).

When the /DISPOFF signal is low, the VM level of the LCD drive voltage is selected, regardless of the values of the data latches (1) and (2) outputs, the DF input, the DF latch (2) output, and the high/low state of the CL1 and $CL2 \cdot \overline{LP}$ signals. When the /DISPOFF signal is low, the VM level is output from the common driver, and the voltage applied to all of the dots becomes 0 V, since the same voltage is applied. This results in a completely blank display.

When either the CL1 or CL2 \cdot LP signal is high, the IC switches the LCD drive voltage and the LCD compensation voltage by comparing the data latch (1) and (2) outputs with the DF input and the DF latch (2) output.

Table 2 lists the LCD drive output pin output voltage levels according to the data latch (1) output (Qn-1), the data latch (2) output (Qn), the CL1 and $CL2 \cdot \overline{LP}$ signals, the DF input, the DF latch (2) output (DFn-1), and the /DISPOFF signal.

Figure 1 presents examples of the LCD drive output pin waveform as driven according to table 2, which appears later. Two examples are presented, one with the DF pin held high, and the other with an LCD alternation signal input to the DF pin.

Table 1-a. Data shift control

In 8-bit parallel input mode (MOD = low)

	(55	<i>(</i> =.				Shift clock					
SHL	/ER	/EL			1	2	•••	n	•••	29	30
Low	Input	Output	D7	\rightarrow	O240	O232		O8(30-n)+8		O16	O8
			D6	\rightarrow	O239	O231		O8(30-n)+7		O15	O7
			D5	\rightarrow	O238	O230		O8(30-n)+6		O14	O6
			D4	\rightarrow	O237	O229	•••	O8(30-n)+5	•••	O13	O5

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■ Function Descriptions (continued)

Table 1-a. Data shift control (continued)

In 8-bit parallel input mode (MOD = low)

								•	•		
	(55	/					Shift	clock			
SHL	/ER	/EL			1	2	•••	n	•••	29	30
Low	Input	Output	D3	\rightarrow	O236	O228		O8(30-n)+4		O12	O4
			D2	\rightarrow	O235	O227		O8(30-n)+3	•••	O11	O3
			D1	\rightarrow	O234	O226		O8(30-n)+2		O10	O2
			D0	\rightarrow	O233	O225		O8(30-n)+1		O9	O1
High	Output	Input	D7	\rightarrow	O1	O9		O8n-7		O225	O233
			D6	\rightarrow	O2	O10		O8n-6	•••	O226	O234
			D5	\rightarrow	O3	O11		O8n-5	•••	O227	O235
			D4	\rightarrow	O4	O12		O8n-4		O228	O236
			D3	\rightarrow	O5	O13		O8n-3		O229	O237
			D2	\rightarrow	O6	O14		O8n-2		O230	O238
			D1	\rightarrow	Ο7	O15		O8n-1		O231	O239
			D0	\rightarrow	O8	O16		O8n	,	O232	O240

Table 1-b. Data shift control

In 12-bit parallel input mode (MOD = high)

	(55	<i>(</i> =.					Shift	clock			
SHL	/ER	/EL			1	2		n	•••	19	20
Low	Input	Output	D11	\rightarrow	O240	O228		O12(20-n)+12		O24	O12
			D10	\rightarrow	O239	O227		O12(20-n)+11		O23	O11
			D9	\rightarrow	O238	O226		O12(20-n)+10		O22	O10
			D8	\rightarrow	O237	O225		O12(20-n)+9		O21	O9
			D7	\rightarrow	O236	O224		O12(20-n)+8		O20	O8
			D6	\rightarrow	O235	O223		O12(20-n)+7		O19	O7
			D5	\rightarrow	O234	O222		O12(20-n)+6		O18	O6
			D4	\rightarrow	O233	O221		O12(20-n)+5		O17	O5
			D3	\rightarrow	O232	O220		O12(20-n)+4		O16	O4
			D2	\rightarrow	O231	O219		O12(20-n)+3		O15	O3
			D1	\rightarrow	O230	O218		O12(20-n)+2		O14	O2
			D0	\rightarrow	O229	O217	•••	O12(20-n)+1	•••	O13	O1
High	Output	Input	D11	\rightarrow	O1	O13		O12n-11		O217	O229
			D10	\rightarrow	O2	O14		O12n-10		O218	O230
			D9	\rightarrow	O3	O15		O12n-9		O219	O231
			D8	\rightarrow	O4	O16	•••	O12n-8	•••	O220	O232
			D7	\rightarrow	O5	O17	•••	O12n-7	•••	O221	O233
			D6	\rightarrow	O6	O18		O12n-6		O222	O234
			D5	\rightarrow	O7	O19	•••	O12n-5	•••	O223	O235
			D4	\rightarrow	O8	O20	•••	O12n-4	•••	O224	O236
			D3	\rightarrow	O9	O21		O12n-3		O225	O237
			D2	\rightarrow	O10	O22	•••	O12n-2	•••	O226	O238
			D1	\rightarrow	O11	O23	•••	O12n-1	•••	O227	O239
			D0	\rightarrow	O12	O24		O12n		O228	O240

■ Function Descriptions (continued)

Table 2. LCD drive output pin output voltage

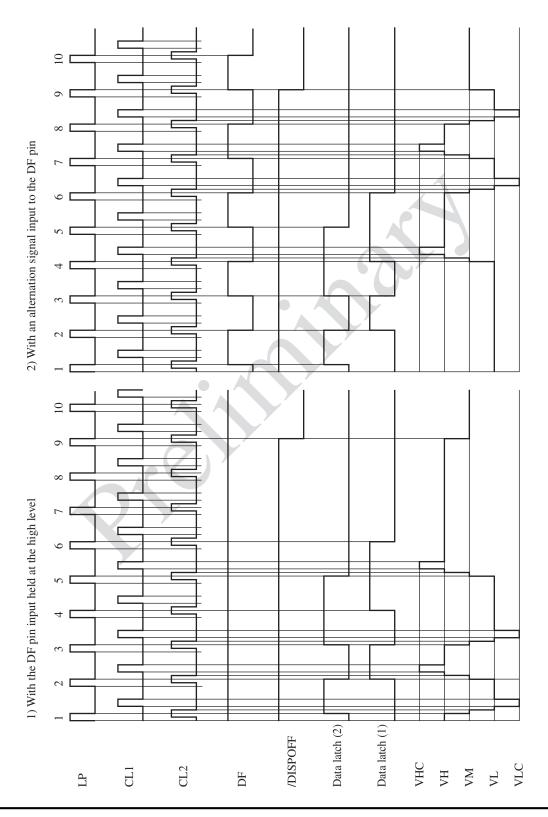
/DISPOFF	CL1	CL2 · LP	DF latch (2) output DFn-1	DF input	Data latch (1) output Qn-1	Data latch (2) output Qn	LCD drive output O1 to O240
High	High	Low	High	High	High	High	VL
						Low	VHC
					Low	High	VLC
						Low	VH
				Low	High	High	VHC
						Low	VL
					Low	High	VH
						Low	VLC
			Low	High	High	High	VLC
						Low	VH
					Low	High	VL
						Low	VHC
				Low	High	High	VH
						Low	VLC
				• A	Low	High	VHC
					,	Low	VL
	Low	High	High	High	High	High	VL
						Low	VM
					Low	High	VM
						Low	VH
				Low	High	High	VM
						Low	VL
					Low	High	VH
		PK				Low	VM
			Low	High	High	High	VM
				_		Low	VH
					Low	High	VL
						Low	VM
				Low	High	High	VH
						Low	VM
					Low	High	VM
						Low	VL
		Low	*	High	*	High	VL
						Low	VH
				Low		High	VH
						Low	VL
Low	*	*	*	*	*	*	VM

Note) 1. *: Don't care

- 2. The timing charts for the IC blocks are presented on the following pages.
- 3. The IC is specified to operate as follows: when the DF input is high, the output is inverted with respect to the actual input data.
- 4. To provide correct display, either the input data must be inverted, or an input to the DF pin that is inverted with respect to that of the common driver must be provided.

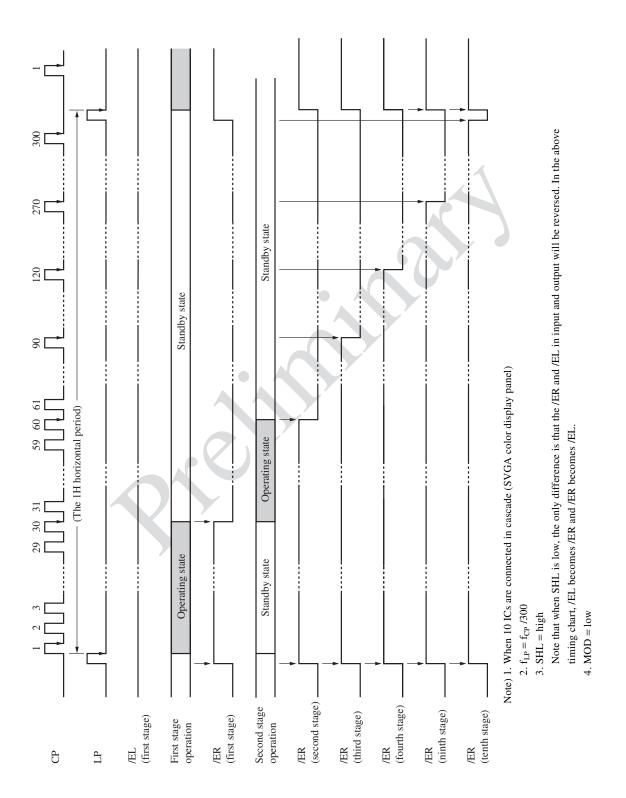
■ Function Descriptions (continued)

Figure 1. LCD drive output waveform examples

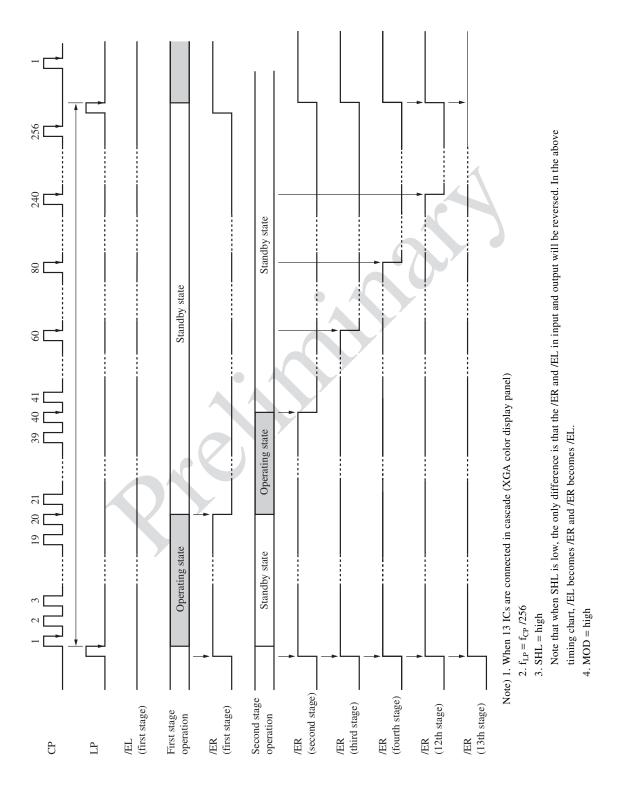


■ Timing Charts

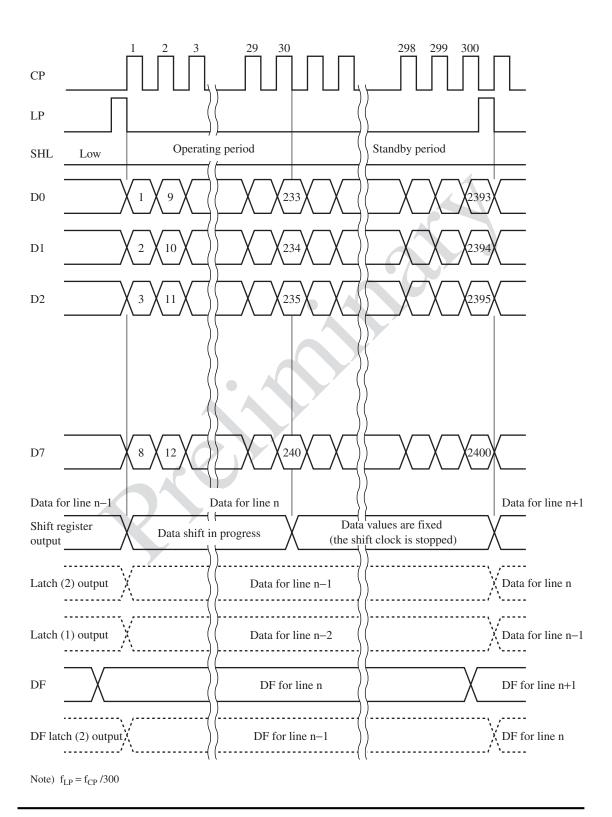
1. Counter and chip enable pins (8-bit parallel input mode)



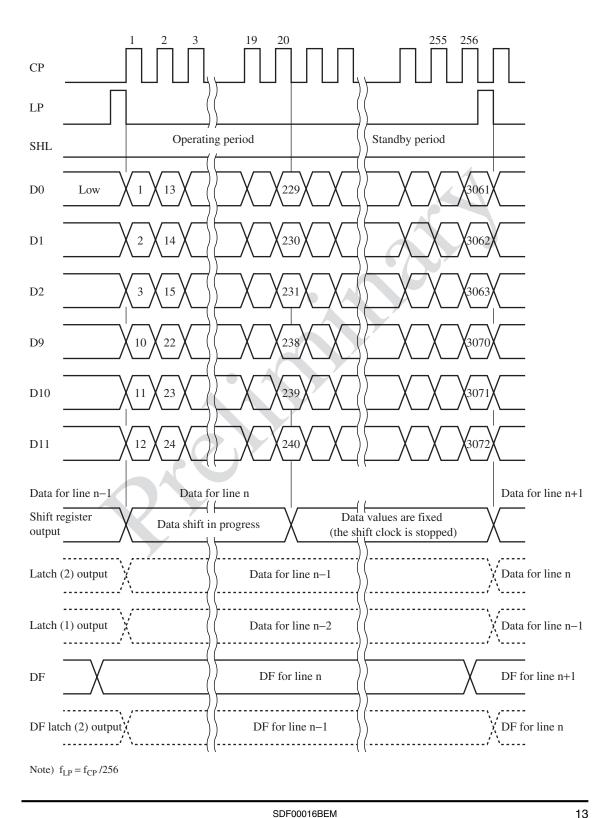
- Timing Charts (continued)
- 2. Counter and chip enable pins (12-bit parallel input mode)



3. Shift register and latch operation (SVGA LCD panel)

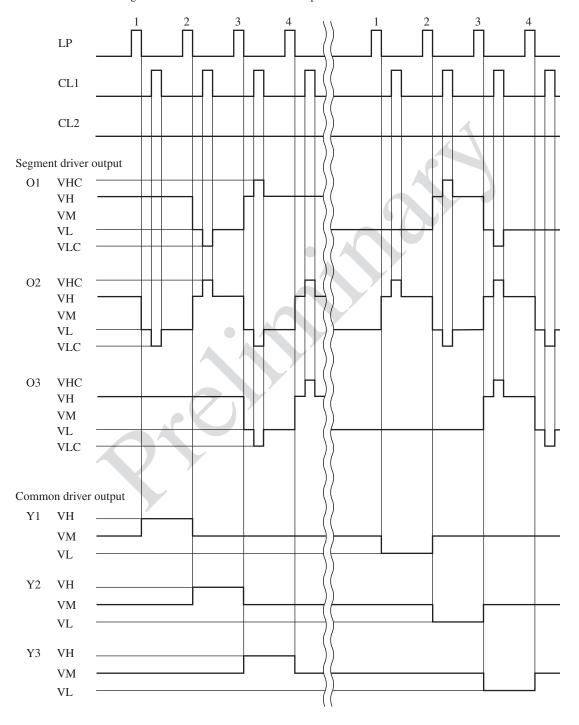


4. Shift register and latch operation (XGA LCD panel)



5. Segment and common driver LCD output waveforms (when /DISPOFF is high)

MN863830EFH Segment and Common Driver LCD Output Waveforms



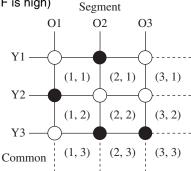
6. LCD display and LCD applied voltage waveforms (when /DISPOFF is high)

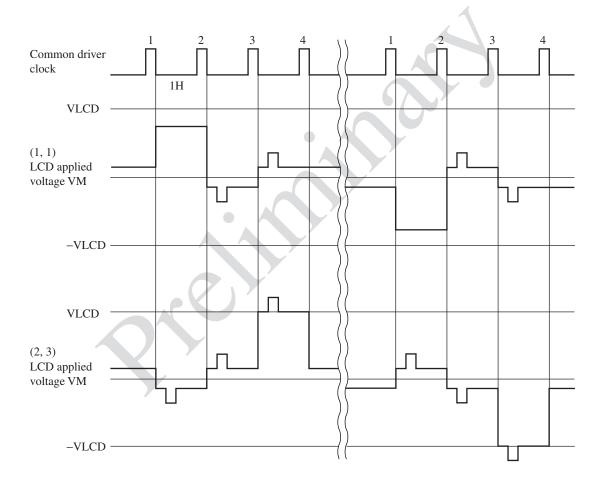
When the drive outputs shown in section 5 are applied, if the display is normally white, the display will be shown in the right figure.

If the display is normally black, then the display will be set up for black/white reversed display. The waveforms of the voltages applied to (1,1) and (2,3) dots in the right figure are shown below.

Note that the applied voltages are referenced to the common side drive voltage VM, and therefore displayed as V_{COM} – V_{SEG} .

$$VLCD = V_{COM} - V_{SEG}$$





Note) 1. When the LCD voltage applied to a dot is ±VLCD, it will be displayed as black in normally white mode and as white in normally black mode.

Since the drive waveform is dulled at the segment drive waveform transition and the actual voltage drops, this IC applies the compensation voltage at the drive waveform transition to compensate the actual voltage.

■ LCD Drive Voltage Names and Relationships (Reference)

The figure presents the LCD drive voltage provided by this IC and the MN8637 series common drivers, and the relationships between those voltages.

Logic supply voltage Segment LCD Segment LCD Common LCD Common LCD drive waveforms drive voltage drive waveforms Segment/common drive voltage (MN863830/MN8637) (MN863830) (MN8637) VH(= 32 V)VHC (= 4.2 V) V_{DD} (= 3.0 V to 5.5 V) — VH (= 3.9 V) VM (= 2.1 V)VL = (= 0.3 V)----- VLC (= $V_{SS} = 0 \text{ V}$) (/DISPOFF = high)VL(=-27.8 V)

■ Electrical Characteristics

1. Absolute Maximum Ratings at $V_{SS} = 0 \text{ V}$, $T_a = 25^{\circ}\text{C}$

Parameter	Symbol	Rating	Unit
Farameter	Symbol	nating	Offit
Supply voltage 1	V_{DD}	- 0.3 to +7.0	V
Supply voltage 2	VHC	- 0.3 to +7.0	V
Drive voltage	V _n	- 0.3 to VHC+0.3	V
Input voltage	VIN	- 0.3 to V _{DD} +0.3	V
Operating temperature	Topr	-20 to +75	°C
Storage temperature	T_{stg}	-40 to +125	°C

- Note) 1. The absolute maximum ratings are limiting values for applied stresses below which the chip will not be destroyed. Operation is not guaranteed within these ranges.
 - 2. These ratings are guarantees that apply when the standard Matsushita packages are used.
 - 3. The term V_n above refers to VHC, VH, VM, VL, and VLC. These must be set up so that the following conditions hold: $VHC \ge VH \ge VLC \ge V_{SS}$.
 - 4. When power is first applied, certain voltage application sequences may result in large currents flowing in this IC and permanent damage to the IC. To prevent this, always apply the logic system power supply levels (V_{DD} and V_{SS}) first, and only after those levels are established apply the LCD drive system power supply levels. Note that the conditions in note 3 above must be met at all times during this process.

2. Operating Conditions at $V_{SS} = 0 \text{ V}$, $T_a = -20 ^{\circ}\text{C}$ to $75 ^{\circ}\text{C}$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Supply voltage	V _{DD}		2.5	3.3	5.5	V
Drive voltage	VHC		3.0	4.2	6.0	V
Drive voltage	VH		VHC-0.7	VHC-0.3	VHC	V
Drive voltage	VM		VL	_	VH	V
Drive voltage	VL		0	0.3	0.7	V



2. Operating Conditions at $V_{SS} = 0$ V, $T_a = -20$ °C to 75°C (continued)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Clock frequency	f_{cp}	$V_{DD} = 2.5 \text{ V to } 4.5 \text{ V}$		_	30	MHz
		$V_{\rm DD} = 4.5 \text{ V to } 5.5 \text{ V}$	_	_	55	MHz
Digital signal input pin capacitance †1	C _{in}	At 1 MHz	_	6	_	pF
Rise and fall time for CP, LP,	t _r , t _f	2.5 V to 4.5 V	_	_	4 †2	ns
and D0 to D11		4.5 V to 5.5 V	_	_	3 †2	ns

Note) 1. †1: CP, D0 to D11

†2: The following condition must be met: $t_r,\,t_f\!\!\leq\!\!1/2(1/f\!\!-\!\!2t_w)$

Here, f is the frequency used and t_w is the minimum pulse width.

- 2. The VLC drive voltage is shorted to V_{SS} internally to the IC. Thus VLC = V_{SS} .
- 3. Connect directly each of the multiple drive supply pins of VHC, VH, VM, VL, and VLC.

3. DC Characteristics at $V_{SS} = 0$ V, $V_{DD} = 2.5$ V to 5.5 V, $T_a = -20^{\circ}\text{C}$ to $+75^{\circ}\text{C}$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Operating supply current	I _{DD}	$f_{CP} = 20 \text{ MHz}$ $f_{Dn} = 10 \text{ MHz}$ $f_{LP} = 36 \text{ kHz}$		2	6	mA
Quiescent supply current (12-bit parallel input mode)	I _{SS1}	In the clock stopped state with MOD = open	_	_	100	μA
Quiescent supply current (8-bit parallel input mode)	I _{SS2}	In the clock stopped state with MOD = low	_	_	500	μΑ
1) Input Pins (SHL, CP, LP, CL	1, CL2, D	F, D0 to D11, /DISPOFF)				
High-level input voltage	V _{IH1}		$0.7 \times V_{DD}$	_	V_{DD}	V
Low-level input voltage	V_{IL1}		0	_	$0.3 \times V_{DD}$	V
Input leakage current	I_{LI1}		-10	_	10	μΑ
2) Input with Pull-up Resistor Pi	ns (MOD))				
High-level input voltage	V _{IH2}		$0.7 \times V_{DD}$	_	V _{DD}	V
Low-level input voltage	V _{IL2}		0	_	$0.3 \times V_{DD}$	V
Pull-up resistance	R _{PU2}	$V_{DD} = 3.3 \text{ V, MOD} = 0 \text{ V}$	30	100	300	ΚΩ
3) I/O Pins (/ER, /EL)						
High-level input voltage	V _{IH3}		$0.7 \times V_{DD}$	_	V_{DD}	V
Low-level input voltage	V _{IL3}		0	_	$0.3 \times V_{DD}$	V
Input leakage current	I _{LI3}		-10	_	10	μΑ
High-level output voltage	V _{OH3}	$I_{OH} = -0.5 \text{ mA}$	V _{DD} -0.5	_	_	V
Low-level output voltage	V _{OL3}	$I_{OL} = 0.5 \text{ mA}$		_	0.5	V
Output leakage current	I_{LO3}		-10	_	10	μΑ

■ Electrical Characteristics at $V_{SS} = 0$ V, $V_{DD} = 2.5$ V to 5.5 V, $T_a = -20$ °C to +75°C (continued) 3. DC Characteristics at $V_{SS} = 0$ V, $V_{DD} = 2.5$ V to 5.5 V, $T_a = -20$ °C to +75°C (continued)

Parameter	Symbol	Condition	s	Min	Тур	Max	Unit
4) LCD Drive Outputs (O1 to O	240)		V _{SS}	= 0 V, V _{DD}	= 2.5 V, T	$G_a = -20$ °C	to +75°C
Output on resistance	R _{ON}	VHC = 4.2 V	VHC	_	450	900	Ω
		VH = 3.9 V	VH	_	450	900	
		VM = 2.1 V	VM	_	450	900	
		VL = 0.3 V	VL	_	450	900	
		VLC = 0.0 V	VLC	_	450	900	
		$V_n - V_O = 0.5 \text{ V}$					
		V _O : Applied voltage			4		
		of O1 to O240					
Output on resistance	R _{ON1}	VHC = 4.2 V		_		200	Ω
Variations between drive voltages		VH = 3.9 V		A		\	
Output on resistance	R _{ON2}	VM = 2.1 V			-	200	Ω
Variations between pins		VL = 0.3 V		6/			
		VLC = 0.0 V					

4. AC Characteristics at $V_{SS}=0$ V, $V_{DD}=2.5$ V to 5.5 V, $T_a=-20^{\circ}C$ to +75°C

Parameter	Symbol	Condition	ons	Min	Тур	Max	Unit
			V _{DD} (V)				
CP cycle time	t _p		2.5 to 4.5	33.3	_	_	ns
			4.5 to 5.5	18	_	_	
CP high-level period	t _{wcH}		2.5 to 4.5	13	_	_	ns
			4.5 to 5.5	6	_	_	
CP low-level period	t _{wcL}		2.5 to 4.5	13	_	_	ns
			4.5 to 5.5	6	_	_	
LP high-level period	t _{wlH}		2.5 to 5.5	40	_	_	ns
LP setup time 1	t _{st1}	CP-LP	2.5 to 4.5	15	_	_	ns
			4.5 to 5.5	10	_	_	
LP setup time 2	t _{st2}	CP-LP	2.5 to 4.5	10	_	_	ns
			4.5 to 5.5	10	_	_	
LP hold time 1	t _{hd1}	CP-LP	2.5 to 4.5	15	_	_	ns
			4.5 to 5.5	10	_	_	
LP hold time 2	t _{hd2}	CP-LP	2.5 to 4.5	50	_	_	ns
			4.5 to 5.5	25	_	_	
Data setup time	t _{st3}	CP-Dx	2.5 to 4.5	12	_	_	ns
			4.5 to 5.5	8	_	_	
Data hold time	t _{hd3}	CP-Dx	2.5 to 4.5	12	_	_	ns
			4.5 to 5.5	7	_	_	

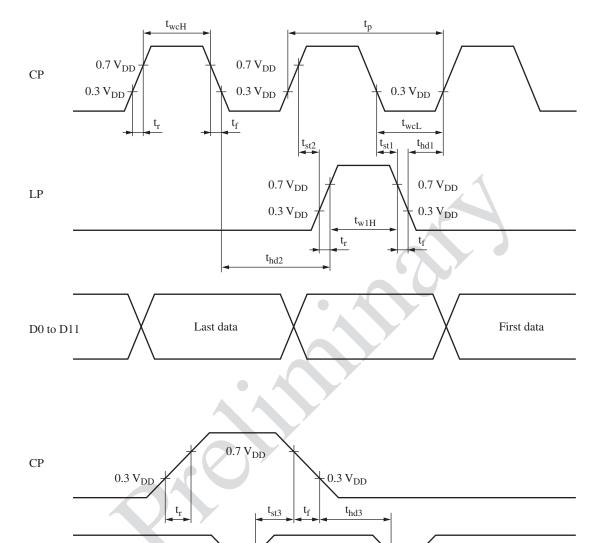
4. AC Characteristics at $V_{SS} = 0$ V, $V_{DD} = 2.5$ V to 5.5 V, $T_a = -20$ °C to +75°C (continued)

Parameter	Symbol	Condition	ons	Min	Тур	Max	Unit
			V _{DD} (V)				
Carry signal setup time	t _{st4}		2.5 to 4.5	12	_		ns
			4.5 to 5.5	6	_		
Carry signal output delay time	t _{d1}		2.5 to 4.5	_	_	21	ns
			4.5 to 5.5	_	_	12	
LP rising edge to CL2 rising edge time	t _{lc1}			18	_	_	ns
CL2 rising edge to LP falling edge time	t _{cl1}			18	7	_	ns
CL2 falling edge to CL1 rising edge time	t _{cc}			2		_	μs
LP rising edge to DF rising edge time, DF falling edge time	t _{ld}			40		_	ns
LCD drive signal output delay time 1	t _{d2}	$LP \rightarrow O_n$		-	_	250	ns
LCD drive signal output delay time 2	t _{d3}	$CL1 \rightarrow O_n$	A	· —	_	250	ns
LCD drive signal output delay time 3	t _{d4}	CL2→O _n		_	_	250	ns
LCD drive signal output delay time 4	t _{d5}	$DF \rightarrow O_n$	7	_	_	250	ns
LCD drive signal output delay time 5	t _{d6}	/DISPOFF→O _r		_	_	250	ns

D0 to D11

■ Electrical Characteristics (continued)

4. AC Characteristics (continued)



0.7 V_{DD}

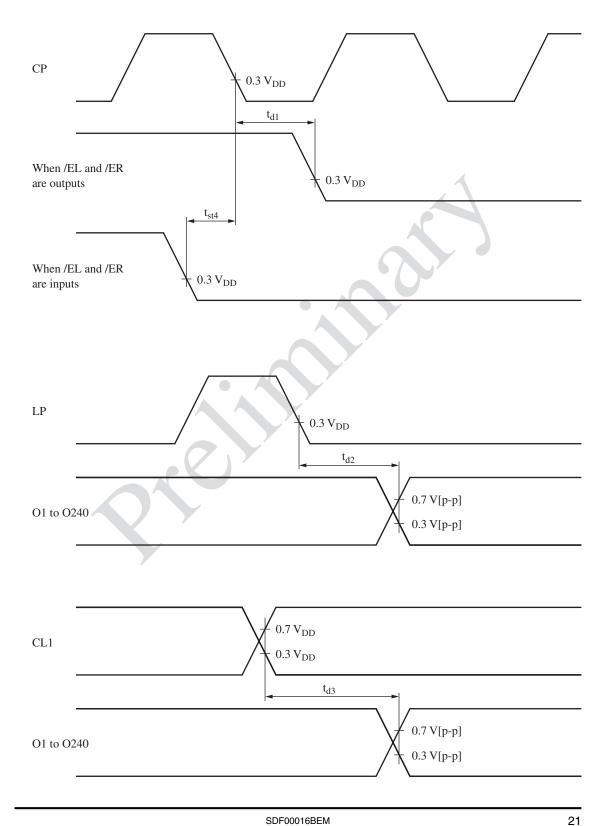
 $0.3\ V_{DD}$

 $0.7\,\mathrm{V_{DD}}$

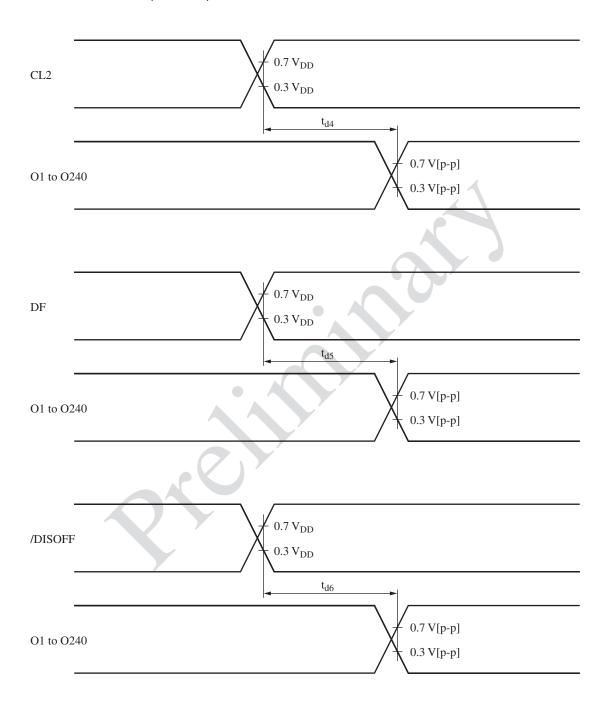
 $0.3 V_{DD}$

 t_r, t_f

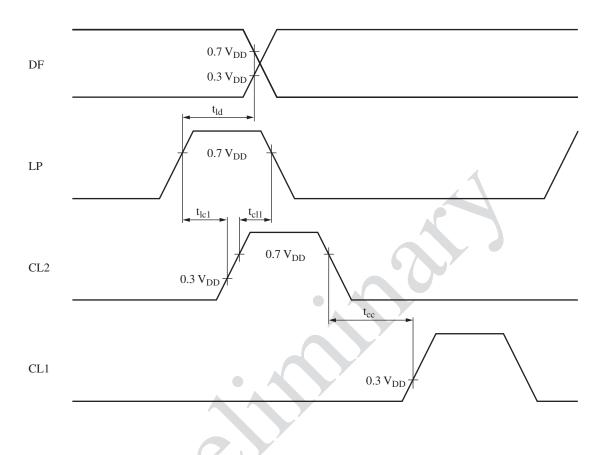
4. AC Characteristics (continued)



4. AC Characteristics (continued)



4. AC Characteristics (continued)



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